Early Warning System

IFC-48999 AT&S Malaysia

Quick Facts

Countries	Malaysia
Specific Location	Hi-Tech Industrial Park
Financial Institutions	International Finance Corporation (IFC)
Status	Approved
Bank Risk Rating	В
Voting Date	2024-12-19
Borrower	AT&S Austria Technologie & Systemtechnik (Malaysia) Sdn. Bhd.
Sectors	Industry and Trade
Investment Type(s)	Loan
Investment Amount (USD)	\$ 250.00 million
Project Cost (USD)	\$ 1,000.00 million



Project Description

According to the Bank's website, the proposed investment is a sustainability linked loan (SLL) of up to US\$400 million (or equivalent in Euros), including up to US\$250 million (or equivalent in Euros) for IFC's own account and up to US\$150 million (or equivalent in Euros) in potential mobilization, to AT&S Austria Technologie & Systemtechnik (Malaysia) Sdn. Bhd. ("AT&S Malaysia" or the "Company"). AT&S Malaysia is a wholly owned subsidiary of AT&S Austria Technologie & Systemtechnik Aktiengesellschaft ("AT&S Austria"). AT&S Austria is a leading global manufacturer of high-end printed circuit boards (PCBs) and integrated circuit (IC) substrates. AT&S Malaysia for some of the key customers. IFC's financing will be utilised to fund the capital expenditure and associated start-up costs / effects (i.e. the expenses until the commencement of mass production) for the first phase of this plant (the "Project").

AT&S Austria has a focus on sustainability and targets to reduce absolute Scope 1 and 2 GHG emissions by 38% by 2030/31 (compared to a baseline of 2021/22). The Project is aligned with the goals of the Paris Agreement.

This is a Category B Project. IFC's loan is solely for IC substrates plant under construction in Kulim Hi-Tech Industrial Park, in Malaysia. The recently completed facility will not be expanded or result in additional E&S risks as part of the investment. Key E&S risks include: (i) need to have a completed and functioning ESMS and capacity to meet IFC PS during operations, including contractor management; (ii) labour, working conditions and OHS; (iii) high energy and water use, pollution prevention controls due to use of hazardous chemicals, solvents, waste handling and wastewater management of metal contaminated etching rinse water; (iv) community health and safety through the project life cycle; (v) supply chain risks (copper, gold and laminates); and (vi) stakeholder engagement given close proximity to residential areas.

Investment Description

• International Finance Corporation (IFC)

The total cost of the Project is estimated at approximately US\$ 1 billion which will be financed by (i) up to US\$250 million (or equivalent in Euros) A Loan for IFC's own account; (ii) up to US\$150 million (or equivalent in Euros) in potential mobilization through B1 Loan and/or Parallel Loans to be provided by other lenders; and (iii) equity and customer advances for the remaining balance.



Private Actors Description

AT&S Malaysia is a 100% owned subsidiary of AT&S Austria. AT&S Austria is a leading global manufacturer of high-end printed circuit boards (PCBs) and integrated circuit (IC) substrates, founded in 1987 and is currently listed on the Vienna Stock Exchange with a market cap of US\$905 million (as of October 10, 2024). Mr. Hannes Androsch and Mr. Willi Dorflinger, along with the related entities own 35.68% of the shares in AT&S Austria while the remaining 64.32% (as of March 31, 2024) of the shares are owned by public shareholders on a free float basis.



Private Actor 1		Private Actor 1 Sector		Private Actor 2	Private Actor 2 Role	Private Actor 2 Sector
-	-	-	-	AT&S Austria Technologie & Systemtechnik (Malaysia) Sdn. Bhd.	Client	-
-	-	-	-	AT&S Austria Technologie & Systemtechnik Aktiengesellschaft	Parent Company	-



Contact Information

AT&S Austria Technologie & Systemtechnik Aktiengesellschaft Klopf Siegfried Head of Treasury Management +43 3842 200 2167 s.klopf@ats.net Fabriksgasse 13, 8700 Leoben, Austria www.ats.net

ACCESS TO INFORMATION

You can submit a request for information disclosure at: https://disclosures.ifc.org/#/inquiries

If you believe that your request for information from IFC has been unreasonably denied, or that this Policy has been interpreted incorrectly, you can submit a complaint at the link above to IFC's Access to Information Policy Advisor, who reports directly to IFC's Executive Vice President.

ACCOUNTABILITY MECHANISM OF IFC/MIGA

The Compliance Advisor Ombudsman (CAO) is the independent complaint mechanism and fact-finding body for people who believe they are likely to be, or have been, adversely affected by an IFC or MIGA- financed project. If you submit a complaint to the CAO, they may assist you in resolving a dispute with the company and/or investigate to assess whether the IFC is following its own policies and procedures for preventing harm to people or the environment. If you want to submit a complaint electronically, you can email the CAO at CAO@worldbankgroup.org You can learn more about the CAO and how to file a complaint at http://www.cao-ombudsman.org



Bank Documents

• Environmental & Social Review Summary (ESRS)